2SA1123

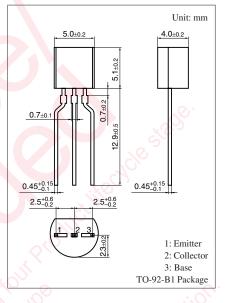
Silicon PNP epitaxial planar type

For low-frequency high breakdown voltage amplification Complementary to 2SC2631

Features

- Satisfactory forward current transfer ratio h_{FE} collector current I_C characteristics.
- \bullet High collector-emitter voltage (Base open) V_{CEO}
- Small collector output capacitance (Common base, input open circuited) C_{ob}
- Makes up a complementary pair with 2SC2631, which is optimum for the pre-driver stage of a 20 W to 40 W output amplifier.

Absolute Maximum Ratings $T_a = 25^{\circ}C$							
Parameter	Symbol	Rating	Unit				
Collector-base voltage (Emitter open)	V _{CBO}	-150	V				
Collector-emitter voltage (Base open)	V _{CEO}	-150	V				
Emitter-base voltage (Collector open)	V _{EBO}	-5	v .				
Collector current	I _C	-50	mA				
Peak collector current	I _{CP}	-100	mA				
Collector power dissipation	P _C	750	mW				
Junction temperature	Tj	150	°C				
Storage temperature	T _{stg}	-55 to +150	°C				



Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

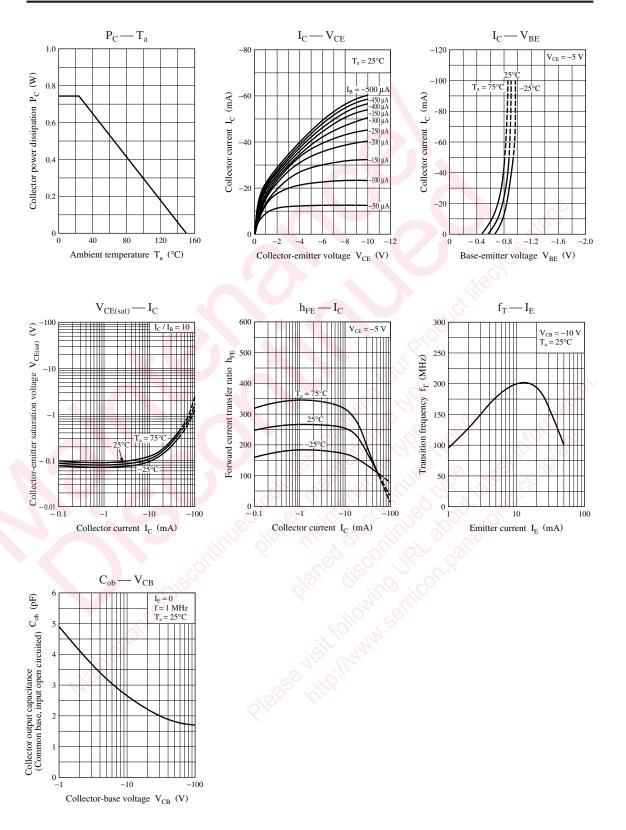
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage (Base open)	V _{CEO}	$I_{\rm C} = -100 \ \mu A, I_{\rm B} = 0$	-150			V
Emitter-base voltage (Collector open)	V _{EBO}	$I_{\rm E} = -10 \ \mu A, I_{\rm C} = 0$	-5			V
Collector-base cutoff current (Emitter open)	I _{CBO}	$V_{CB} = -100 \text{ V}, I_E = 0$			-1	μΑ
Forward current transfer ratio *	h _{FE}	$V_{CE} = -5 \text{ V}, I_C = -10 \text{ mA}$	130		450	_
Collector-emitter saturation voltage	V _{CE(sat)}	$I_{\rm C} = -30$ mA, $I_{\rm B} = -3$ mA			-1	V
Transition frequency	f _T	$V_{CB} = -10 \text{ V}, I_E = 10 \text{ mA}, f = 200 \text{ MHz}$		200		MHz
Collector output capacitance (Common base, input open circuited)	C _{ob}	$V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$			5	pF
Noise voltage	NV	$V_{CE} = -40 \text{ V}, I_C = -1 \text{ mA}, G_V = 80 \text{ dB}$ $R_g = 100 \text{ k}\Omega$, Function = FLAT		150	300	mV

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors. 2. *: Rank classification

Rank	R	S	Т	
\mathbf{h}_{FE}	130 to 220	185 to 330	260 to 450	

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